

2SK1519, 2SK1520

Silicon N Channel MOS FET

REJ03G0948-0300 (Previous: ADE-208-1288) Rev.3.00 Apr 27, 2006

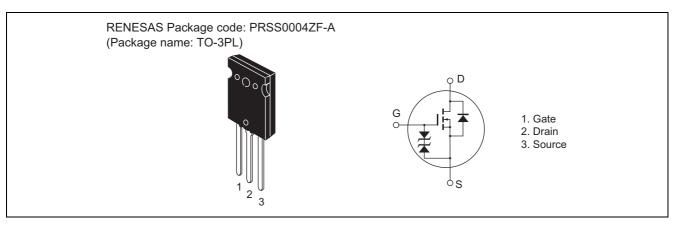
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- Built-in fast recovery diode ($t_{rr} = 120 \text{ ns}$)
- Suitable for motor control, switching regulator, DC-DC converter

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item		Ratings	Unit
2SK1519	V _{DSS}	450	V
2SK1520	Γ	500	
Gate to source voltage		±30	V
	ID	30	А
	I _{D(pulse)} * ¹	120	А
Body to drain diode reverse drain current		30	А
Channel dissipation		200	W
	Tch	150	°C
	Tstg	-55 to +150	°C
	2SK1520	2SK1520 VGSS ID ID ID IDR ID IDR ID ID ID ID	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Notes: 1. PW \leq 10 $\mu s,\,duty\,cycle \leq$ 1%

2. Value at $T_C = 25^{\circ}C$

Electrical Characteristics

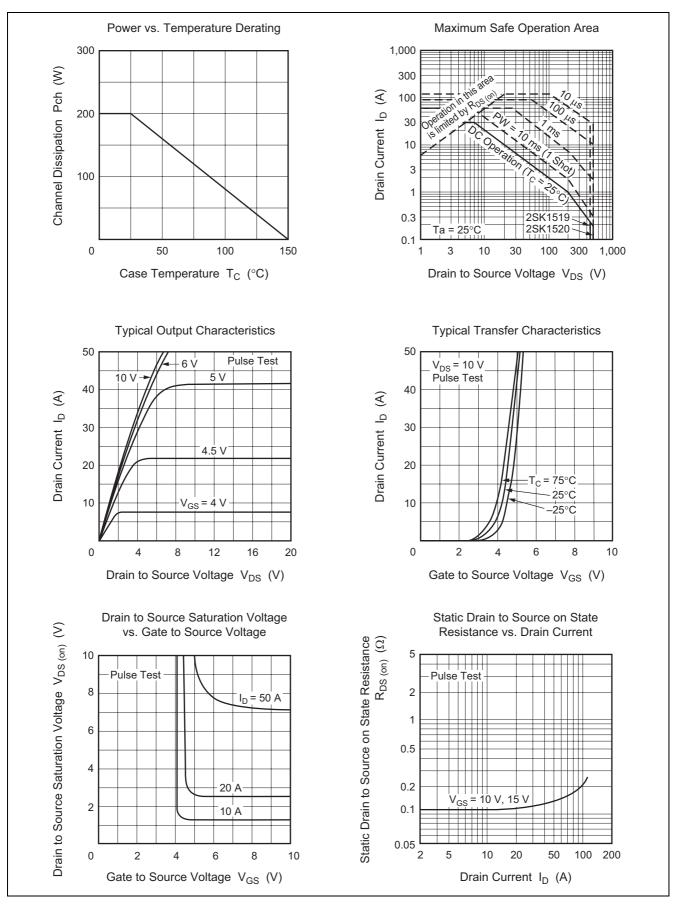
 $(Ta = 25^{\circ}C)$

Item		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	2SK1519	V _{(BR)DSS}	450	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
breakdown voltage	2SK1520		500				
Gate to source breakdow	vn voltage	V _{(BR)GSS}	±30	—	—	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak curre	ent	I _{GSS}	_	—	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain	2SK1519	I _{DSS}	_	—	250	μΑ	$V_{DS} = 360 \text{ V}, V_{GS} = 0$
current	2SK1520						$V_{DS} = 400 V, V_{GS} = 0$
Gate to source cutoff vol	tage	V _{GS(off)}	2.0	—	3.0	V	I _D = 1 mA, V _{DS} = 10 V
Static drain to source on	2SK1519	R _{DS(on)}	_	0.11	0.15	Ω	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$
state resistance	2SK1520		_	0.12	0.16		
Forward transfer admitta	ince	y _{fs}	15	25	—	S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$
Input capacitance		Ciss	_	5800	—	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance		Coss	_	1550	—	pF	f = 1 MHz
Reverse transfer capacit	ance	Crss	_	170	—	pF	
Turn-on delay time		t _{d(on)}	_	65	—	ns	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time		t _r	_	170	—	ns	R _L = 2 Ω
Turn-off delay time		t _{d(off)}	_	415	—	ns	
Fall time		t _f	_	200	—	ns	
Body to drain diode forw	ard voltage	V_{DF}	_	1.1	—	V	$I_F = 30 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery		t _{rr}	_	120	—	ns	$I_F = 30 \text{ A}, V_{GS} = 0,$
time							di _F /dt = 100 A/µs

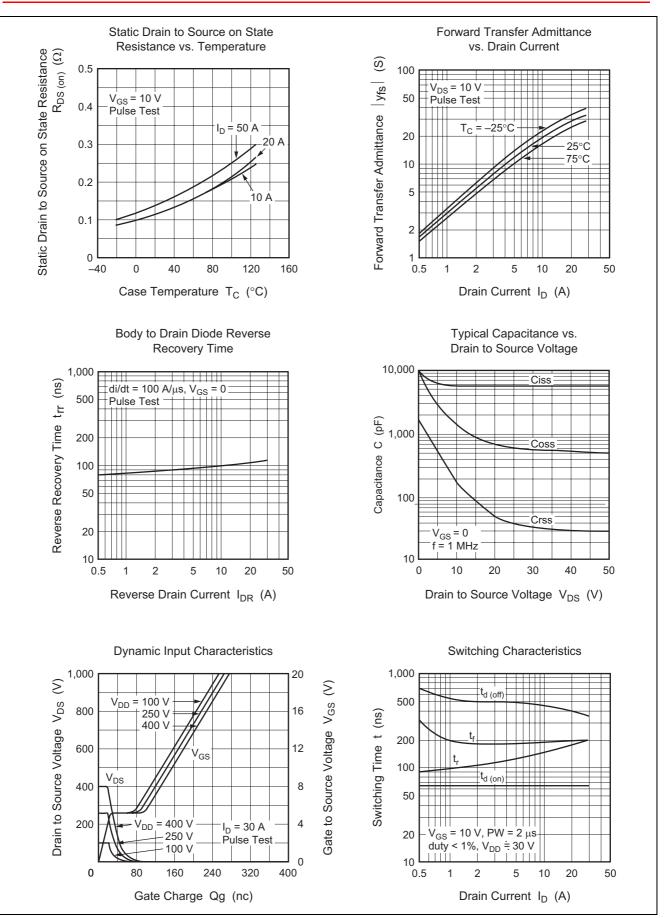
Note: 3. Pulse test



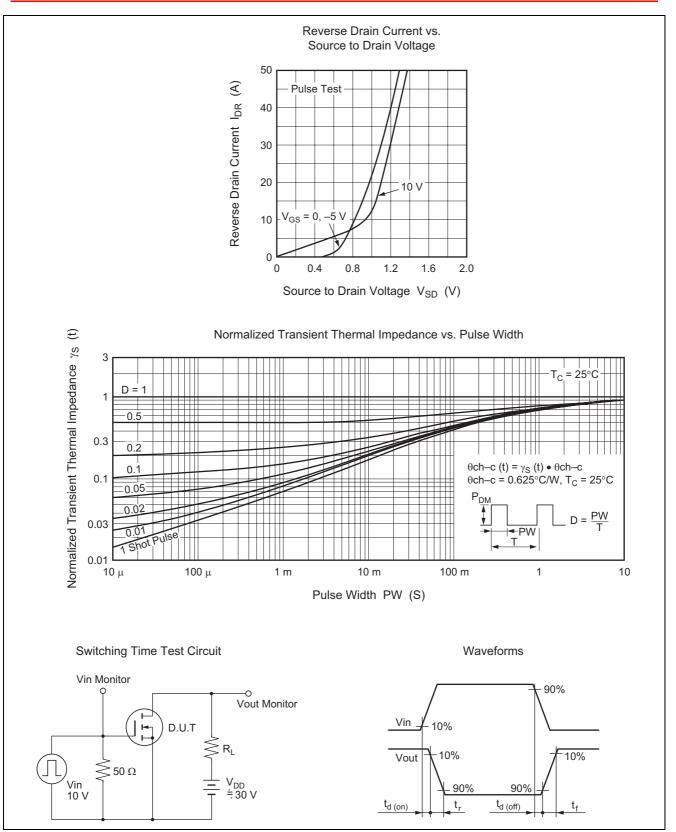
Main Characteristics





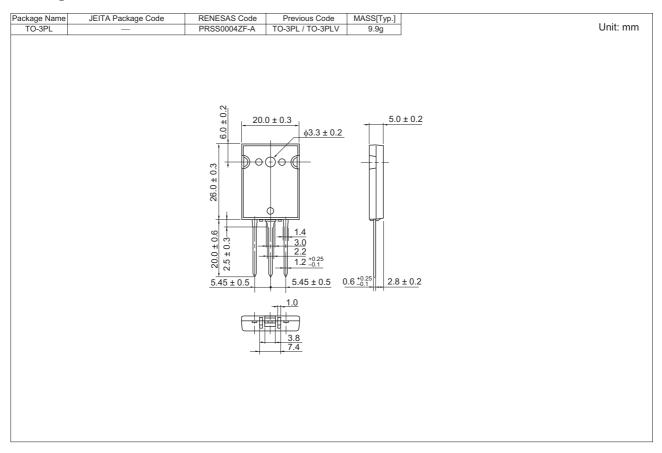








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK1519-E	360 pcs	Box (Tube)
2SK1520-E	360 pcs	Box (Tube)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



Renesas Technology Corp. sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Keep safety first in your circuit designs! 1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

- Notes regarding these materials
 1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.
 2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
 3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.
 The information described here may contain technical inaccuracies or typographical errors. Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors. Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (http://www.renesas.com).
 4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to

- Nonne page (http://www.renessas.com).
 4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage, liability or ther loss resulting from the information contained herein.
 5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
- use. 6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials. 7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination. Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited. 8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.



RENESAS SALES OFFICES

Refer to "http://www.renesas.com/en/network" for the latest and detailed information.

Renesas Technology America, Inc. 450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K. Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology (Shanghai) Co., Ltd. Unit 204, 205, AZIACenter, No.1233 Lujiazui Ring Rd, Pudong District, Shanghai, China 200120 Tel: <86> (21) 5877-1818, Fax: <86> (21) 6887-7898

Renesas Technology Hong Kong Ltd. 7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd. 10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology Singapore Pte. Ltd. 1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd. Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145

Renesas Technology Malaysia Sdn. Bhd Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510

http://www.renesas.com